



SUA-110M4x-x-S235

Shell Material :

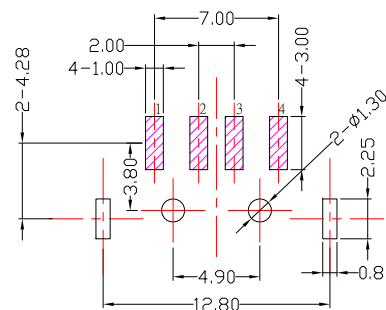
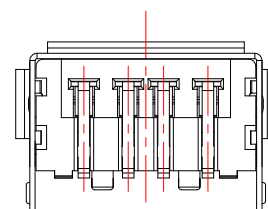
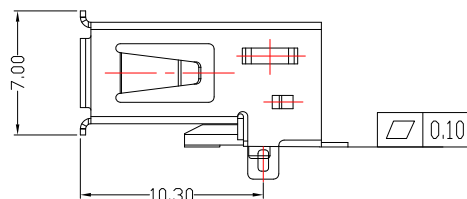
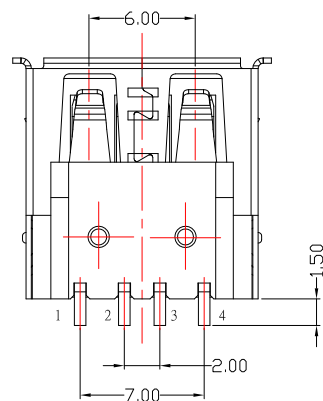
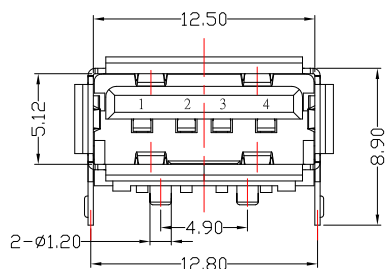
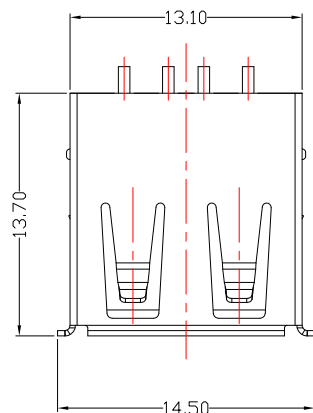
Blank : BRASS

I : SPCC

Color :

White : W

Black : B



RECOMMENDED PCB LAYOUT

SPECIFICATIONS

Electrical:

- 1.Contact Resistance: 30 mΩ Max
- 2.Insulation Resistance: 1,000 MΩ Min
- 3.Dielectric Withstanding Voltage: 500 V AC

Material:

- 1.Housing: LCP , UL 94V-0
- 2.Contact: Phosphor Bronze
- 3.Shell: Brass / SPCC

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer



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CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS
OTHERWISE STATED :

Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 07/21/20
DATE: 07/21/20
DATE: 07/21/20

MATL	TITLE	CONNECTOR
FINISH	MODLE	USB A/F SMT 外殼直腳 有柱
SCALE	DWG NO.	SUA-110M4x-x-S235
SHEET NO.	PART NO.	SUA-110M4x-x-S235

SIZE
A4
VER
R3